

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### SURFACE MOUNT FAST SWITCHING DIODE

## **Features**

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Data Sheet (BAS21WQ)

## **Mechanical Data**

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208 (93)
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe)
- Weight: 0.006 grams (Approximate)









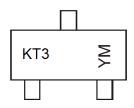
Top View Internal Schematic

## **Ordering Information** (Note 4)

Part Number	Compliance	Case	Packaging
BAS19W-7-F	AEC-Q101	SOT323	3,000/Tape & Reel
BAS20W-7-F	AEC-Q101	SOT323	3,000/Tape & Reel
BAS21W-7-F	AEC-Q101	SOT323	3,000/Tape & Reel
BAS21W-13-F	AEC-Q101	SOT323	10,000/Tape & Reel

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

## **Marking Information**



KT3 = Product Type Marking Code YM = Date Code Marking Y = Year ex: B = 2014

M = Month ex: 9 = September

Date Code Key

Year	2000	2001		2009	2010	2011	2012	201	201	4 2015	2016	2017	2018
Code	L	М		W	Χ	Υ	Z	А	В	С	D	Е	F
Month	Jan	Feb	Mar	Apr	Ма	y Ju	ın	Jul	Aug	Sep	Oct	Nov	Dec
Code	- 1	2	2	1	5	-	3	7	Ω	a	0	Z	D



## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	BAS19W	BAS20W	BAS21W	Unit
Repetitive Peak Reverse Voltage			120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage			100	150	200	V
RMS Reverse Voltage			71	106	141	V
Forward Continuous Current (Note 5)	I <sub>FM</sub>		400		mA	
Average Rectified Output Current (Note 5)	Io		200		mA	
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s		I <sub>FSM</sub>	2.5 0.5		Α	
Repetitive Peak Forward Surge Current			_	625		mA

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation	P <sub>D</sub>	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>0JA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

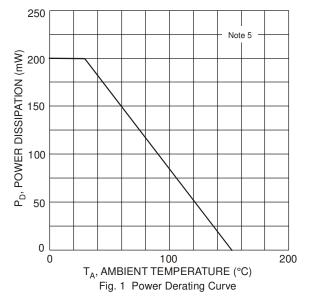
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

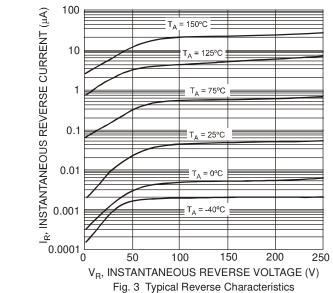
Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 6)	BAS19W BAS20W BAS21W	V <sub>(BR)R</sub>	120 200 250	_ _ _	V	I <sub>R</sub> = 100μA
Forward Voltage		V <sub>F</sub>	_	1.0 1.25	V	I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 6)		I <sub>R</sub>	_	100 15	nA μA	$T_{J} = +25^{\circ}C$ $T_{J} = +100^{\circ}C$
Total Capacitance		C <sub>T</sub>	_	5.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time		t <sub>RR</sub>	_	50	ns	$I_F = I_R = 30 mA,$ $I_{RR} = 0.1 \times I_R, R_L = 100 \Omega$

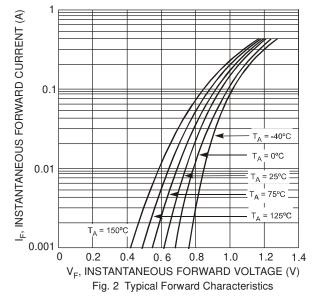
Notes:

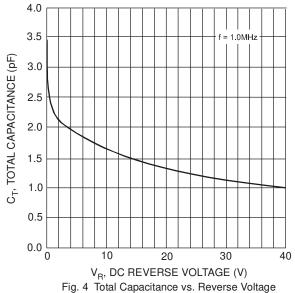
<sup>5.</sup> Part mounted on FR-4 PC board with minimum recommended pad layout per Diodes Inc.'s website at http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.









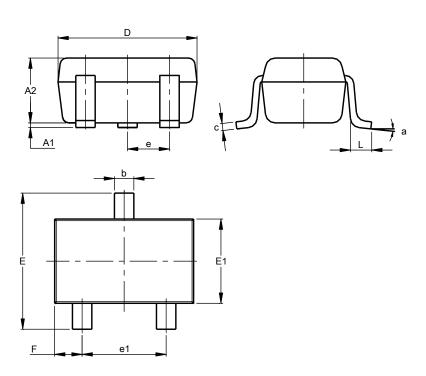




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT323**

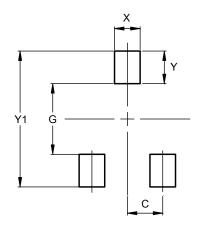


SOT323							
Dim	Min Max Typ						
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.25	0.40	0.30				
C	0.10	0.18	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
e	0.650 BSC						
e1	1.20	1.40	1.30				
F	0.375	0.475	0.425				
L	0.25	0.40	0.30				
а	0°	8°	_				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## SOT323



Dimensions	Value (in mm)			
С	0.650			
G	1.300			
X	0.470			
Υ	0.600			
Y1	2.500			



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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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